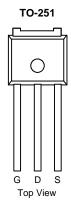


P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
- 60	0.066 at V _{GS} = - 10 V	- 20	40 nC			
- 00	0.080 at V _{GS} = - 4.5 V	- 18	40110			



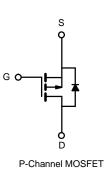
FEATURES

- TrenchFET[®] Power MOSFET
- 100 % UIS Tested

APPLICATIONS

Load Switch





Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 60	V	
Gate-Source Voltage		V _{GS}	± 20		
	T _C = 25 °C		- 20 ^a	A	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C		- 16		
Continuous Drain Current $(1) = 150^{\circ}$ C)	T _A = 25 °C	I _D	- 11 ^b		
	T _A = 70 °C	1	- 9 ^b		
Pulsed Drain Current		I _{DM}	- 100		
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	- 35		
Single Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	101	mJ	
Continuous Source-Drain Diode Current	T _C = 25 °C	I _S	- 29 ^a	А	
Continuous Source-Drain Diode Current	T _A = 25 °C	'S	- 2.1 ^b	А	
	T _C = 25 °C	- P _D	35 ^a	w	
Maximum Power Dissipation	T _C = 70 °C		20 ^a		
	T _A = 25 °C		3.0 ^b		
	T _A = 70 °C		2 ^b		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	33	40	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	0.98	1.2	0.00	

Notes:

a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface mounted on 1" x 1" FR4 board.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μΑ		68		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i _D = - 250 μA		- 5.2		mv/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μA	
		V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 55 °C			- 10		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 120			Α	
	Р	V _{GS} = - 10 V, I _D = - 30 A		0.066	1		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 20 A		0.080		Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 50 A	20			S	
Dynamic ^b							
Input Capacitance	C _{iss}			1200		pF	
Output Capacitance	C _{oss}	V_{DS} = - 25 V, V_{GS} = 0 V, f = 1 MHz		200			
Reverse Transfer Capacitance	C _{rss}			150			
Tatal Qata Ohama	0	$V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -55$ A		40		nC	
Total Gate Charge	Qg			38			
Gate-Source Charge	Q _{gs}	$V_{\rm DS}$ = - 30 V, $V_{\rm GS}$ = - 4.5 V, $I_{\rm D}$ = - 55 A		16			
Gate-Drain Charge	Q _{gd}			19			
Gate Resistance	Rg	f = 1 MHz		5.2		Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	V_{DD} = - 2 V, R_L = 2 Ω		7	15	- ns	
Turn-Off Delay Time	t _{d(off)}	$I_{D}\cong$ - 10 A, V_{GEN} = - 10 V, R_{g} = 1 Ω		70	110		
Fall Time	t _f			40	60		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 66	A	
Pulse Diode Forward Currenta	I _{SM}				- 150		
Body Diode Voltage	V _{SD}	I _S = - 30 A		- 1	- 1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			45	68	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			59	120	nC	
Reverse Recovery Fall Time	ta	I _F = - 50 A, di/dt = 100 A/μs, T _J = 25 °C		29			
Reverse Recovery Rise Time	t _b			16		ns	

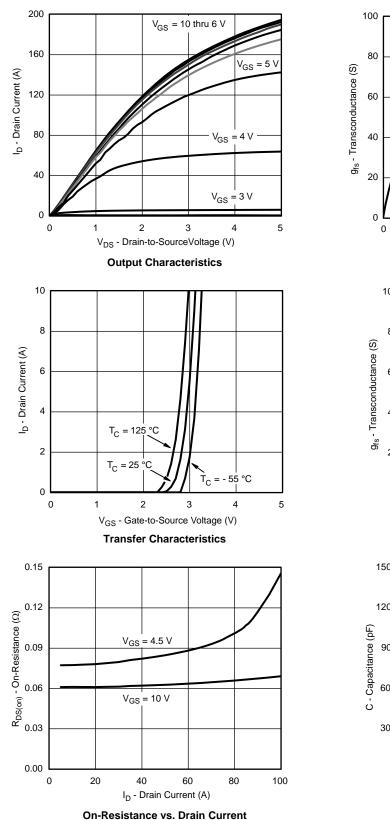
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

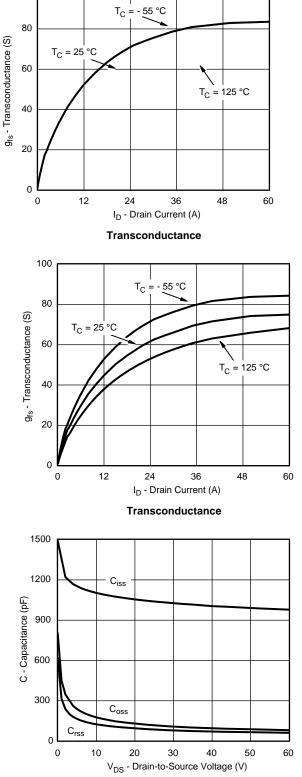
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





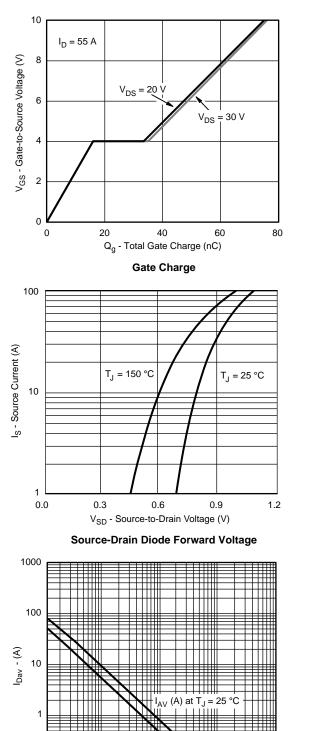
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Capacitance

服务热线:400-655-8788





TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

 $\label{eq:Tin-s} T_{\text{in}} \text{-} (s)$ Single Pulse Avalanche Current Capability vs. Time

0.01

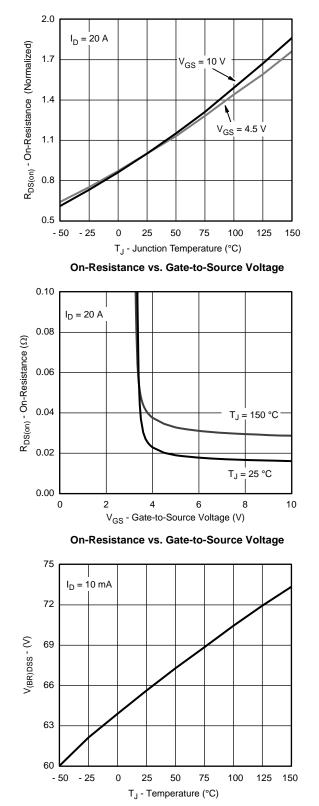
0.1

1

11111

 I_{AV} (A) at T_{J} = 150

0.001

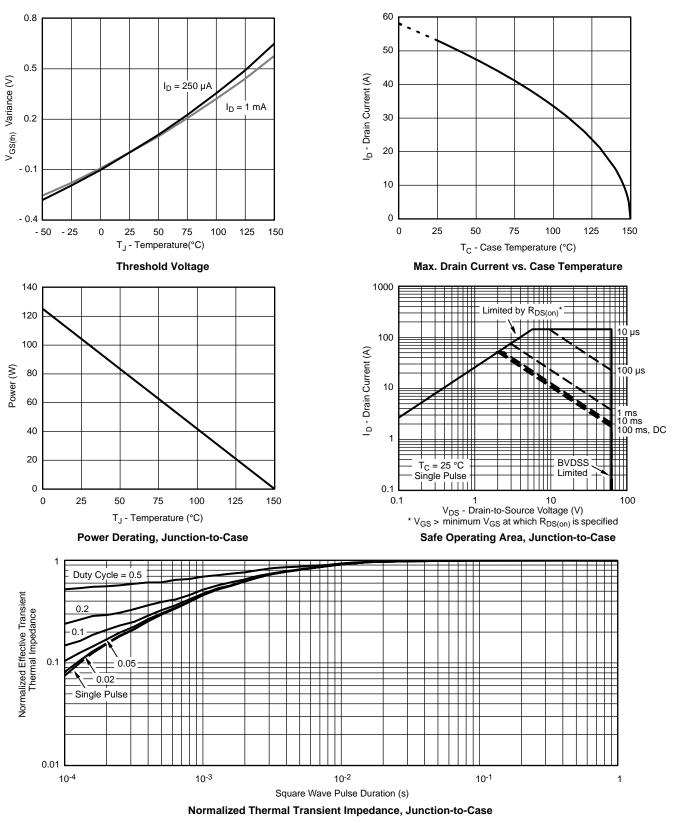


Drain-Source Breakdown Voltage vs. Junction Temperature

0.1

0.0001

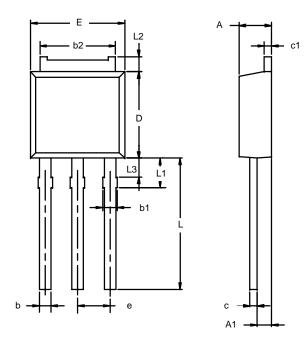




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

	MILLIN	IETERS	INC	HES	
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090 BSC		
L	8.89	9.53	0.350	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	
ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5346					



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